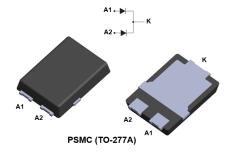




Automotive 30 V, dual 3 A power Schottky rectifier



Features



- PPAP capable
- 150 °C maximum operation junction temperature
- V_{RRM} guaranteed from -40 °C to 150 °C
- · High surge current capability
- ECOPACK2 compliant component

Application

- · Reverse polarity protection in E.C.U
- DC/DC converters
- Freewheeling diodes

Description

The STPS630CSFY has been developed for applications requiring an optimized VF and leakage current characteristics.

These characteristics make it ideal for use in secondary rectification functions, such as DC/DC converters or freewheeling functions.

Product status link
STPS630CSFY

Product summary			
Symbol	Value		
I _{F(AV)}	2 X 3 A		
V _{RRM}	30 V		
T _j (max.)	150 °C		
V _F (typ.)	0.32 V		



1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage (T _j = -40 °C to +150 °C)			30	V
1	Average forward ourrent \$ = 0.5	Per diode	T _c = 140 °C	3	Α
I _{F(AV)}	Average forward current, $\delta = 0.5$	Per device	T _c = 140 °C	6	A
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			120	Α
P _{ARM}	Repetitive peak avalanche power t_p = 10 μ s, T_j = 125 $^{\circ}$ C			60	W
T _{stg}	Storage temperature range			-65 to +175	°C
Tj	Operating junction temperature range ⁽¹⁾			-40 to +150	°C

^{1.} $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	Тур.	Unit
R _{th(j-c)}	Junction to case total	1.50	°C/W

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I_ (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-		95	μA
IR ^(*)		T _j = 125 °C		-	20	35	mA
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 3 A	-	0.41	0.45	
		T _j = 125 °C		-	0.32	0.37	
V ₋ (2)		T _j = 25 °C	I _F = 4 A	-	0.43	0.47	V
VF.		T _j = 125 °C		-	0.35	0.40	V
		T _j = 25 °C	I _F = 6 A	-	0.47	0.52	
		T _j = 125 °C		-	0.41	0.47	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

 $P = 0.23 \times I_{F(AV)} + 0.047 \times I_{F}^{2}_{(RMS)}$

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

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^{2.} Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$



1.1 Characteristics (curves)

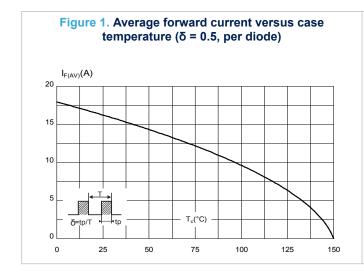


Figure 2. Relative variation of thermal impedance junction

Figure 3. Reverse leakage current versus reverse voltage applied (typical values, per diode)

1.E+02

1.E+01

1.E+01

1.E-01

1.E-03

0 5 10 15 20 25 30

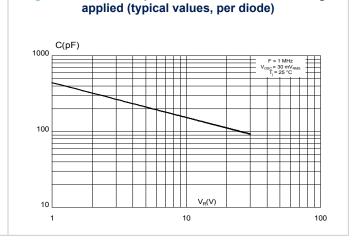
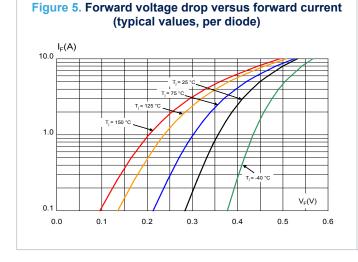
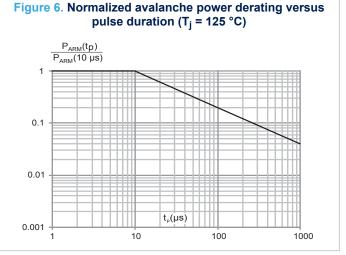


Figure 4. Junction capacitance versus reverse voltage

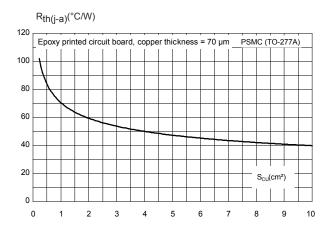




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Figure 7. Thermal resistance junction to ambient versus copper surface under tab (typical values, epoxy printed board FR4, e_{Cu} = 70 μ m) (PSMC (TO-277A))



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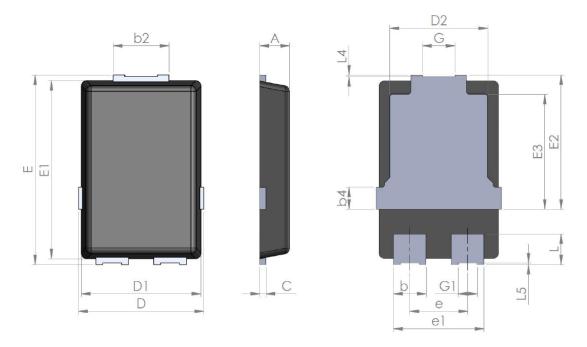
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 PSMC (TO-277A) package information

- Epoxy meets UL94,V0
- Cooling method : by conduction (C)

Figure 8. PSMC (TO-277A) package outline



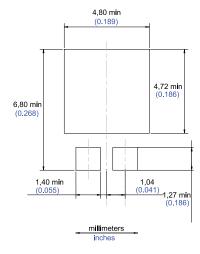
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Table 4. PSMC (TO-277A) package mechanical data

	Dimensions						
Ref.		Millimeters	eters In		iches (for reference only)		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	1.00	1.10	1.20	0.039	0.043	0.047	
b	1.05	1.20	1.35	0.041	0.047	0.053	
b2	1.90	2.05	2.20	0.075	0.081	0.087	
b4		0.75			0.029		
С	0.15	0.23	0.40	0.006	0.009	0.016	
D	4.45	4.60	4.75	0.175	0.181	0.187	
D1	4.25	4.40	4.45	0.167	0.173	0.175	
D2	3.40	3.60	3.70	0.134	0.142	0.146	
E	6.35	6.50	6.65	0.250	0.256	0.262	
E1	6.05	6.10	6.15	0.238	0.240	0.242	
E2	4.50	4.60	4.70	0.177	0.181	0.185	
E3		3.94			1.55		
е		2.13			0.084		
e1		3.33			0.131		
G		1.20			0.047		
G1		0.70			0.027		
L	0.90	1.05	1.24	0.035	0.041	0.049	
L4	0.02			0.0008			
L5	0.02			0.0008			

Figure 9. PSMC (TO-277A) package footprint in mm (in inches)



Note: For package and tape orientation, reel and inner box dimensions and tape outline please check TN1173

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3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS630CSFY	PS630CY	PSMC (TO-277A)	90 mg	6000	Tape and Reel

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Revision history

Table 6. Document revision history

Date	Version	Changes
26-Oct-2020	1	Initial release.

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